IEC 61784-2-3

Edition 1.0 2023-03

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE

colour inside

## Industrial networks – Profiles – Part 2-3: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3 – CPF 3

## Réseaux industriels – Profils – Partie 2-3: Profils de bus de terrain supplémentaires pour les réseaux en temps réel fondés sur l'ISO/IEC/IEEE 8802-3 – CPF 3



IEC 61784-2-3:2023-03(en-fr)



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# INDUSTRIAL NETWORKS – PROFILES –

# Part 2-3: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3 – CPF 3

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IEC 61784-2-3 has been prepared by subcommittee 65C: Industrial networks, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This first edition, together with the other parts of the same series, cancels and replaces the fourth edition of IEC 61784-2 published in 2019. This first edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to IEC 61784-2:2019:

a) split of the original IEC 61784-2 into several subparts, one subpart for the material of a generic nature, and one subpart for each Communication Profile Family specified in the original document;
b) addition of new profile CP 3/7;
c) update of the requirements for all conformance classes;
d) updated timing requirements for IO devices;
e) refining the added application classes.

The text of this International Standard is based on the following documents:

| Draft | Report on voting |
|---|---|
| 65C/1209/FDIS | 65C/1237/RVD |

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

A list of all parts of the IEC 61784-2 series, published under the general title *Industrial networks – Profiles – Part 2: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3*, can be found on the IEC website.

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# INTRODUCTION

The IEC 61784-2 series provides additional Communication Profiles (CP) to the existing Communication Profile Families (CPF) of the IEC 61784-1 series and additional CPFs with one or more CPs. These profiles meet the industrial automation market objective of identifying Real-Time Ethernet (RTE) communication networks coexisting with ISO/IEC/IEEE 8802-3 – commonly known as Ethernet. These RTE communication networks use provisions of ISO/IEC/IEEE 8802-3 for the lower communication stack layers and additionally provide more predictable and reliable real-time data transfer and means for support of precise synchronization of automation equipment.

More specifically, these profiles help to correctly state the compliance of RTE communication networks with ISO/IEC/IEEE 8802-3, and to avoid the spreading of divergent implementations.

Adoption of Ethernet technology for industrial communication between controllers and even for communication with field devices promotes the use of Internet technologies in the field area. This availability would be unacceptable if it causes the loss of features required in the field area for industrial communication automation networks, such as:

- real-time,
- synchronized actions between field devices like drives,
- efficient, frequent exchange of very small data records.

These new RTE profiles can take advantage of the improvements of Ethernet networks in terms of transmission bandwidth and network span.

Another implicit but essential requirement is that the typical Ethernet communication capabilities, as used in the office world, are fully retained, so that the software involved remains applicable.

The market is in need of several network solutions, each with different performance characteristics and functional capabilities, matching the diverse application requirements. RTE performance indicators, whose values will be provided with RTE devices based on communication profiles specified in the IEC 61784-2 series, enable the user to match network devices with application-dependent performance requirements of an RTE network.

# INDUSTRIAL NETWORKS – PROFILES –

# Part 2-3: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3 – CPF 3

## 1 Scope

This part of IEC 61784-2 defines extensions of Communication Profile Family 3 (CPF 3) for Real-Time Ethernet (RTE). CPF 3 specifies a set of Real-Time Ethernet (RTE) communication profiles (CPs) and related network components based on the IEC 61158 series (Type 10), ISO/IEC/IEEE 8802-3 and other standards.

For each RTE communication profile, this document also specifies the relevant RTE performance indicators and the dependencies between these RTE performance indicators.

NOTE 1 All CPs are based on standards or draft standards or International Standards published by the IEC or on standards or International Standards established by other standards bodies or open standards processes.

NOTE 2 The RTE communication profiles use ISO/IEC/IEEE 8802-3 communication networks and its related network components and in some cases amend those standards to obtain RTE features.

NOTE 3 Some CPs of CPF 3 are specified in IEC 61784-1-3.

## 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE All parts of the IEC 61158 series, as well as the IEC 61784-1 series and the IEC 61784-2 series, are maintained simultaneously. Cross-references to these documents within the text therefore refer to the editions as dated in this list of normative references.

IEC 61158 (all parts), *Industrial communication networks – Fieldbus specifications*

IEC 61158-5-10:2023, *Industrial communication networks – Fieldbus specifications – Part 5-10: Application layer service definition – Type 10 elements*

IEC 61158-6-10:2023, *Industrial communication networks – Fieldbus specifications – Part 6-10: Application layer protocol specification – Type 10 elements*

IEC 61784-1-3:2023, *Industrial networks – Profiles – Part 1-3: Fieldbus profiles – Communication Profile Family 3*

IEC 61784-2-0:2023, *Industrial networks – Profiles – Part 2-0: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3 – General concepts and terminology*

IEC 61784-3-3:2021, *Industrial communication networks – Profiles – Part 3-3: Functional safety fieldbuses – Additional specifications for CPF 3*

IEC 61784-5-3:2018, *Industrial communication networks – Profiles – Part 5-3: Installation of fieldbuses – Installation profiles for CPF 3*

IEC 62439-2:2021*, Industrial communication networks – High availability automation networks – Part 2: Media Redundancy Protocol (MRP)*

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# 3 Terms, definitions, abbreviated terms, acronyms, symbols and conventions

## 3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 61784-2-0, ISO/IEC/IEEE 8802-3, IEEE Std 802-2014, IEEE Std 802.1AB-2016, IEEE Std 802.1AS-2020 and IEEE Std 802.1Q-2018 apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at https://www.electropedia.org/
- ISO Online browsing platform: available at https://www.iso.org/obp

## 3.2 Abbreviated terms and acronyms

For the purposes of this document, abbreviated terms and acronyms defined in IEC 61784-2-0 and the following apply.

| | |
|---|---|
| API | Application Process Identifier |
| AR | Application Relationship |
| ARP | Address Resolution Protocol (see IETF RFC 826) |
| ASE | Application Service Element |
| BMCA | Best Master Clock Algorithm |
| CBS | Committed Burst Size |
| CIM | Communication Interface Management |